



SGM8631/2/3/4

470 μ A, 6MHz, Rail-to-Rail I/O

CMOS Operational Amplifiers

PRODUCT DESCRIPTION

The SGM8631 (single), SGM8632 (dual), SGM8633 (single with shutdown) and SGM8634 (quad) are low noise, low voltage, and low power operational amplifiers, that can be designed into a wide range of applications. The SGM8631/2/3/4 have a high gain-bandwidth product of 6MHz, a slew rate of 3.7V/ μ s, and a quiescent current of 470 μ A/amplifier at 5V. The SGM8633 has a power-down disable feature that reduces the supply current to 90nA.

The SGM8631/2/3/4 are designed to provide optimal performance in low voltage and low noise systems. They provide rail-to-rail output swing into heavy loads. The input common mode voltage range includes ground, and the maximum input offset voltage are 3.5mV for SGM8631/2/3/4. They are specified over the extended industrial temperature range (-40°C to +125°C). The operating range is from 2.5V to 5.5V.

The SGM8631 single is available in Green SC70-5, SOT-23-5 and SOIC-8 packages. The SGM8632 dual is available in Green SOIC-8 and MSOP-8 packages. The SGM8633 single with shutdown is available in Green SOT-23-6 and SOIC-8 packages. The SGM8634 quad is available in Green TSSOP-14 and SOIC-14 packages.

FEATURES

- Low Cost
- Rail-to-Rail Input and Output
 0.8mV Typical V_{os}
- High Gain-Bandwidth Product: 6MHz
- High Slew Rate: 3.7V/ μ s
- Settling Time to 0.1% with 2V Step: 2.1 μ s
- Overload Recovery Time: 0.9 μ s
- Low Noise: 12nV/ $\sqrt{\text{Hz}}$
- Supply Voltage Range: 2.5V to 5.5V
- Input Voltage Range: -0.1V to +5.6V with $V_s = 5.5V$
- Low Supply Current
 470 μ A/Amplifier (TYP)
 90nA Shutdown Current for SGM8633
- Small Packaging
 - SGM8631 Available in SC70-5, SOT-23-5 and SOIC-8
 - SGM8632 Available in MSOP-8 and SOIC-8
 - SGM8633 Available in SOT-23-6 and SOIC-8
 - SGM8634 Available in TSSOP-14 and SOIC-14

APPLICATIONS

- Sensors
- Audio
- Active Filters
- A/D Converters
- Communications
- Test Equipment
- Cellular and Cordless Phones
- Laptops and PDAs
- Photodiode Amplification
- Battery-Powered Instrumentation

PACKAGE/ORDERING INFORMATION

MODEL	ORDER NUMBER	PACKAGE DESCRIPTION	PACKAGE OPTION	MARKING INFORMATION
SGM8631	SGM8631XC5/TR	SC70-5	Tape and Reel, 3000	8631
	SGM8631XN5/TR	SOT-23-5	Tape and Reel, 3000	8631
	SGM8631XS/TR	SOIC-8	Tape and Reel, 2500	SGM8631XS
SGM8632	SGM8632XMS/TR	MSOP-8	Tape and Reel, 3000	SGM8632XMS
	SGM8632XS/TR	SOIC-8	Tape and Reel, 2500	SGM8632XS
SGM8633	SGM8633XN6/TR	SOT-23-6	Tape and Reel, 3000	8633
	SGM8633XS/TR	SOIC-8	Tape and Reel, 2500	SGM8633XS
SGM8634	SGM8634XS14/TR	SOIC-14	Tape and Reel, 2500	SGM8634XS14
	SGM8634XTS14/TR	TSSOP-14	Tape and Reel, 3000	SGM8634XTS14

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, +V _S to -V _S	7.5V
Common Mode Input Voltage.....(-V _S) - 0.5V to (+V _S) + 0.5V	
Storage Temperature Range.....	-65°C to +150°C
Junction Temperature.....	160°C
Operating Temperature Range.....	-55°C to +150°C
Package Thermal Resistance @ T _A = 25°C	
SC70-5, θ _{JA}	333°C/W
SOT-23-5, θ _{JA}	190°C/W
SOT-23-6, θ _{JA}	190°C/W
SOIC-8, θ _{JA}	125°C/W
MSOP-8, θ _{JA}	216°C/W
Lead Temperature (Soldering 10sec)	260°C
ESD Susceptibility	
HBM.....	1500V
MM.....	400V

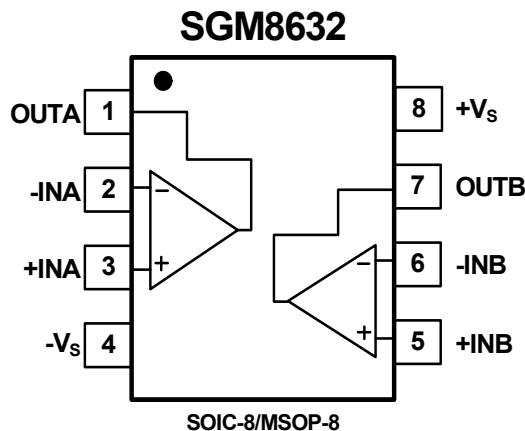
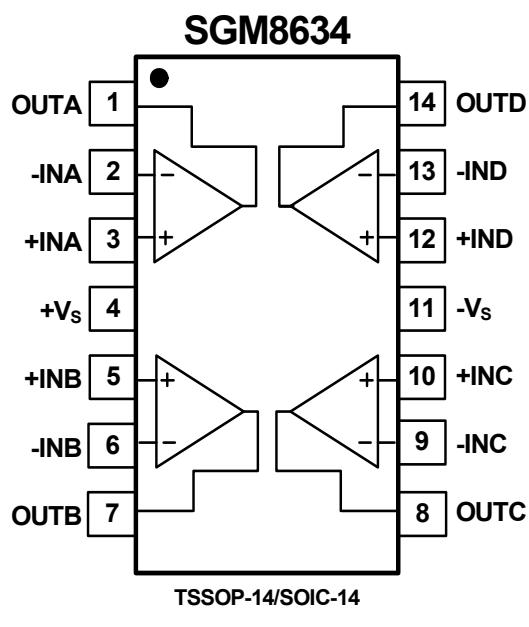
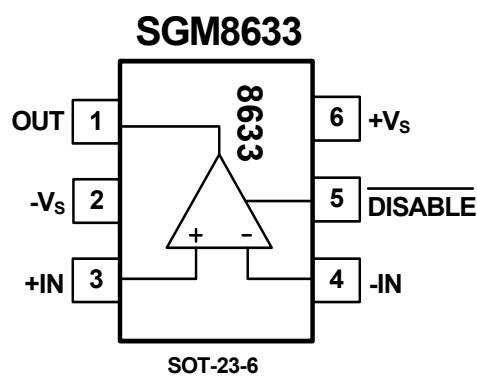
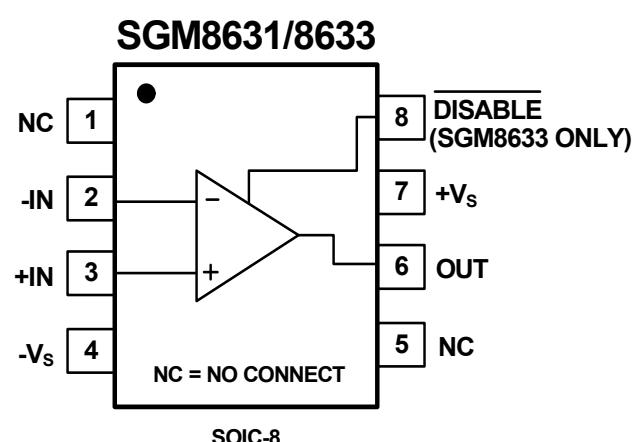
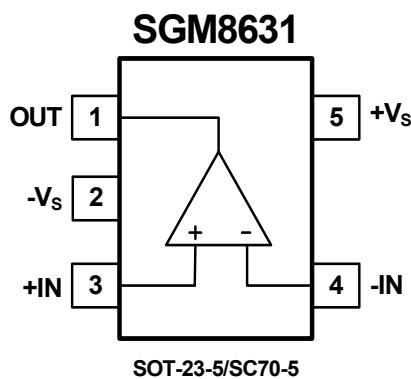
NOTE:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

SGMICRO reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time. Please contact SGMICRO sales office to get the latest datasheet.

PIN CONFIGURATIONS (TOP VIEW)

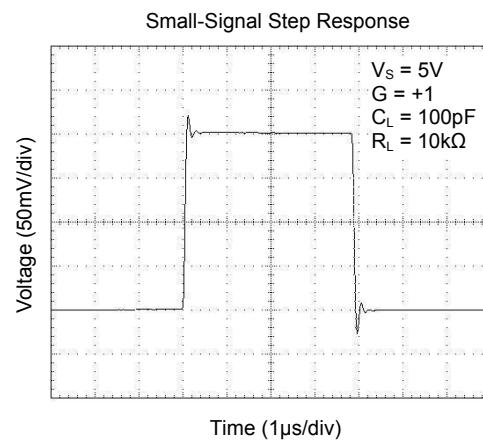
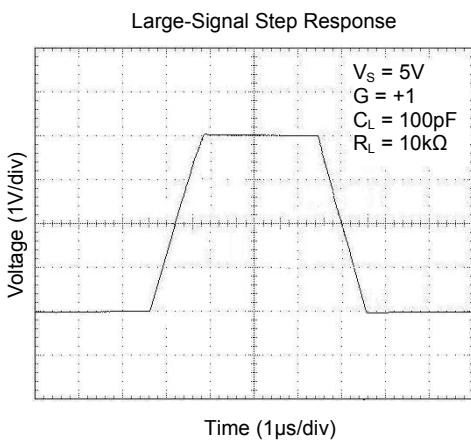
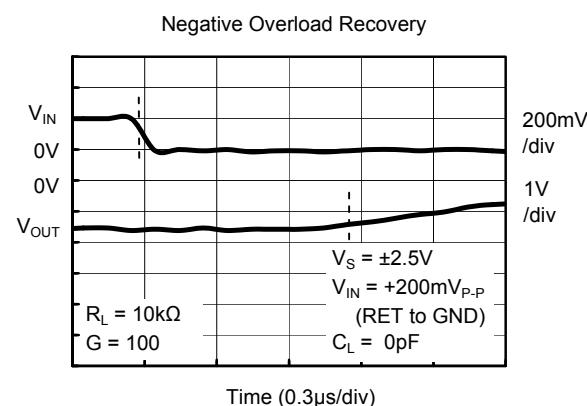
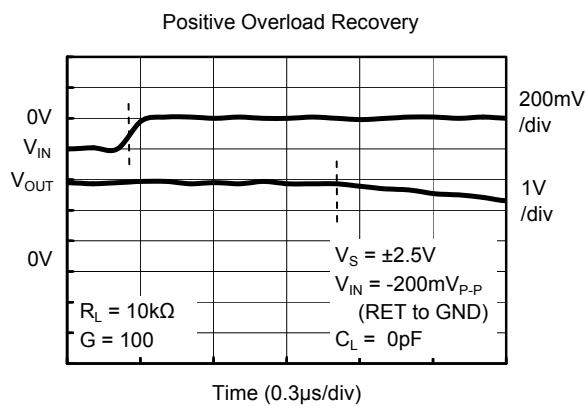
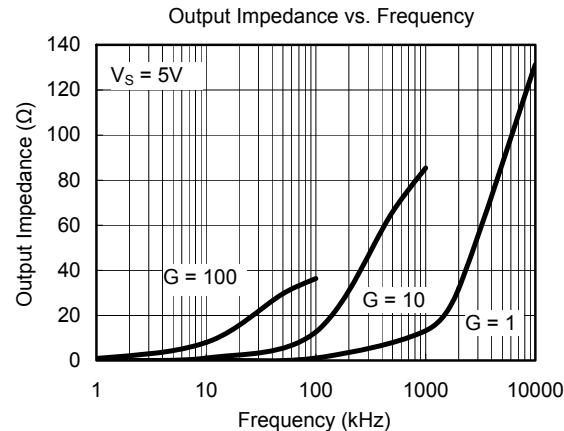
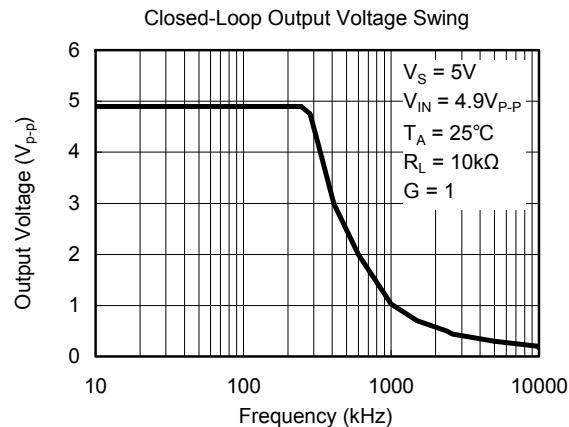
SGM8631/2/3/4

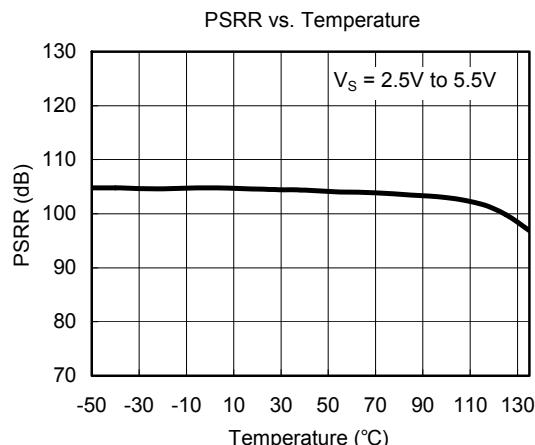
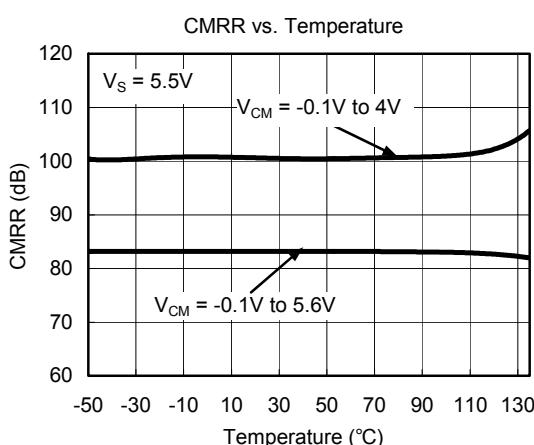
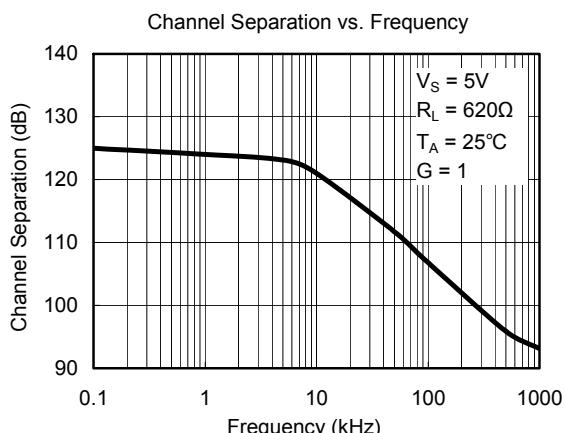
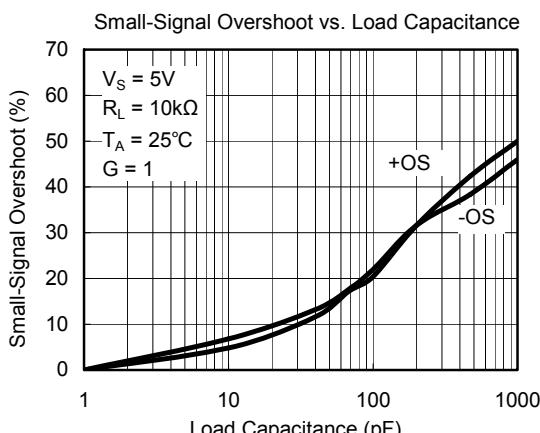
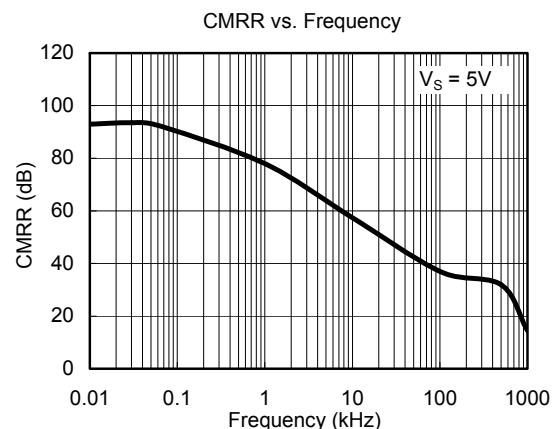
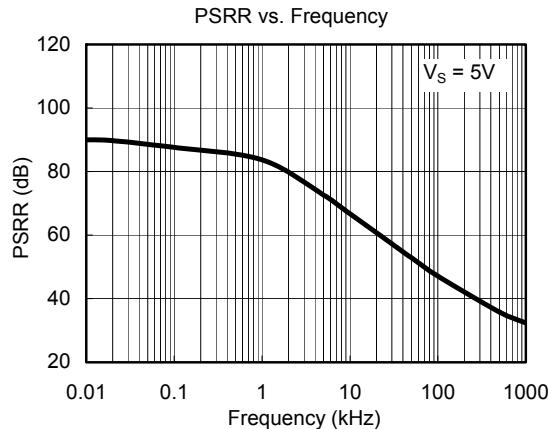
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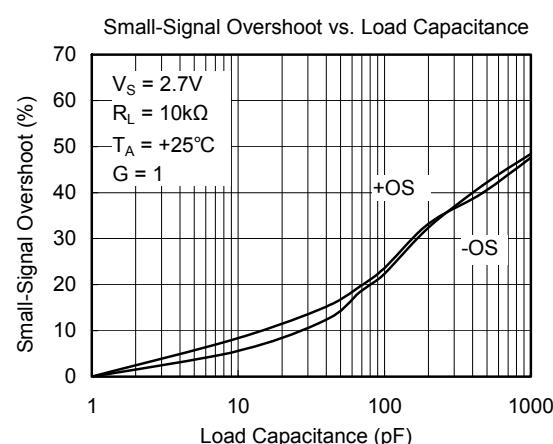
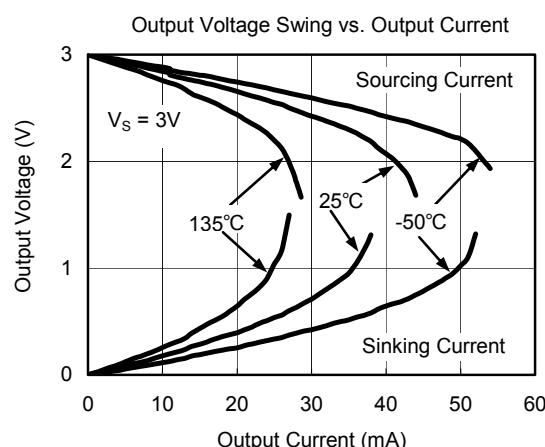
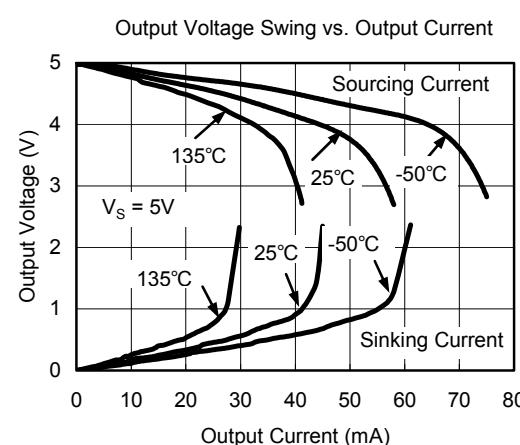
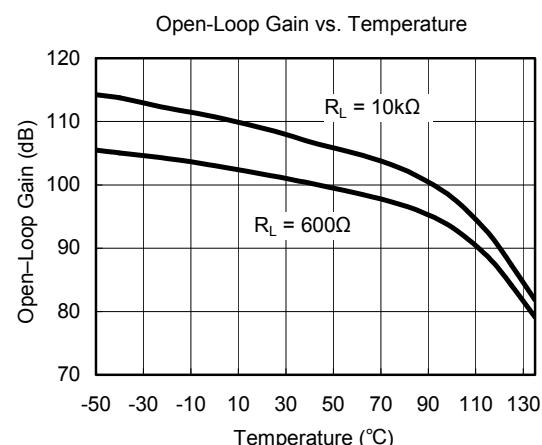
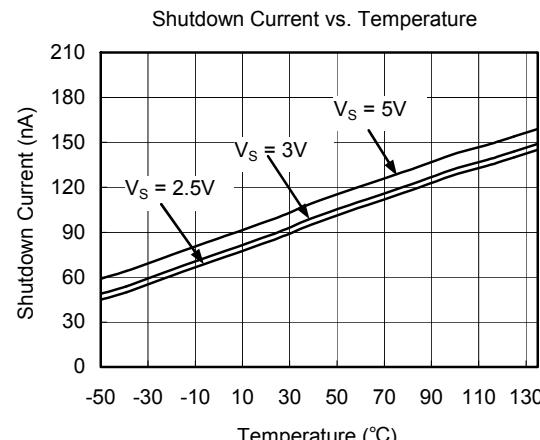
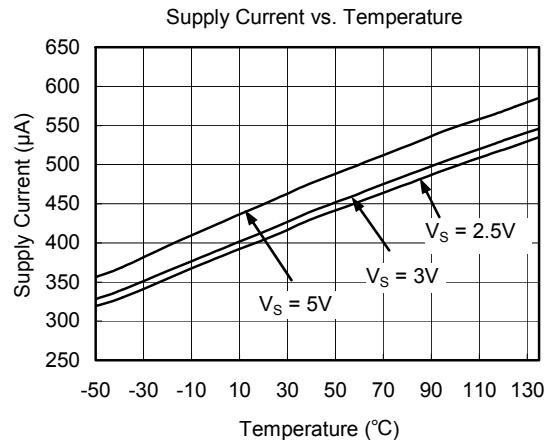
ELECTRICAL CHARACTERISTICS: $V_S = +5V$

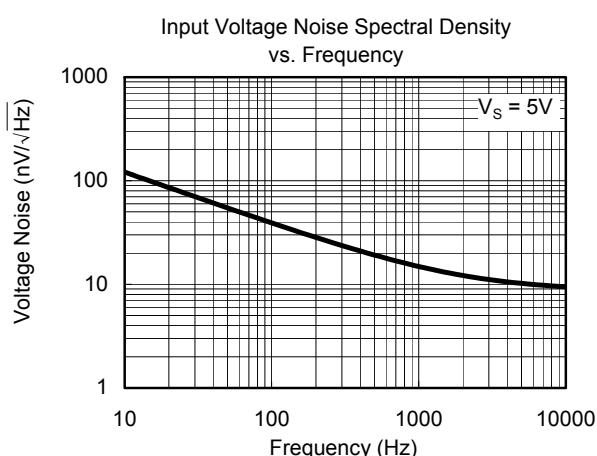
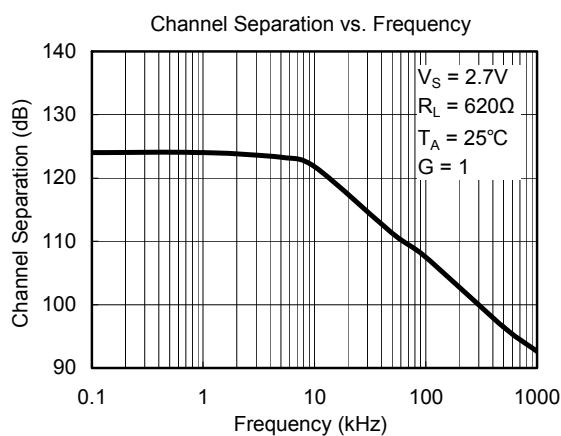
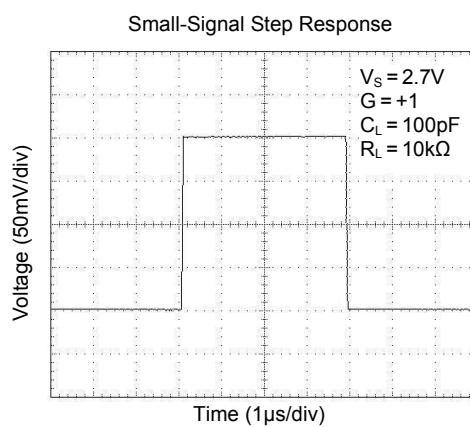
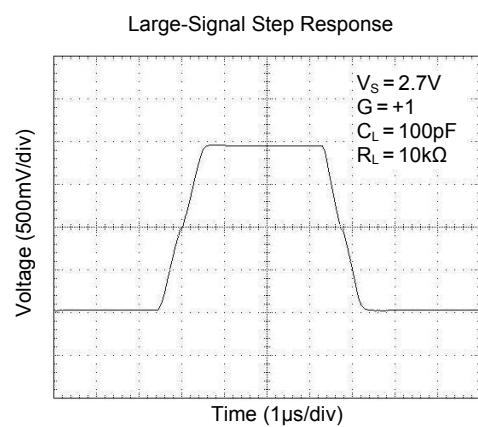
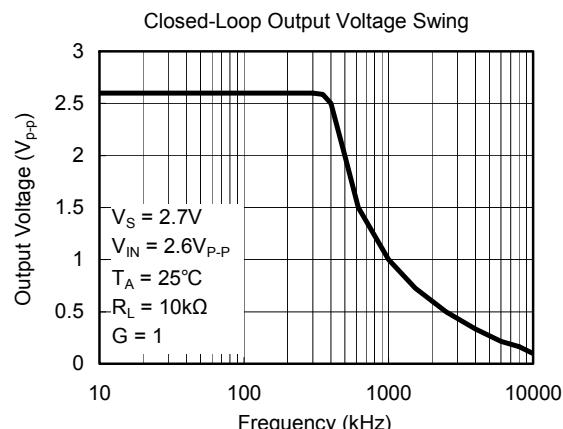
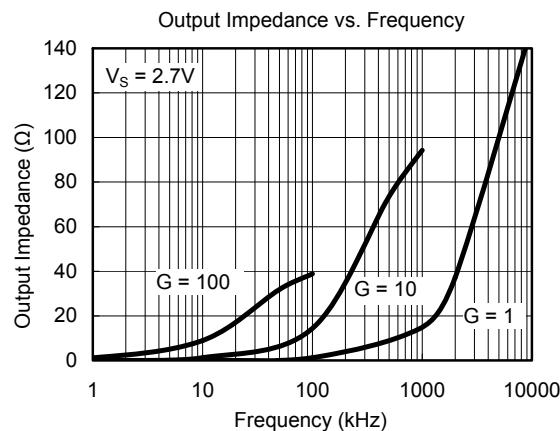
(At $T_A = +25^\circ C$, $V_{CM} = V_S/2$, $R_L = 600\Omega$, unless otherwise noted.)

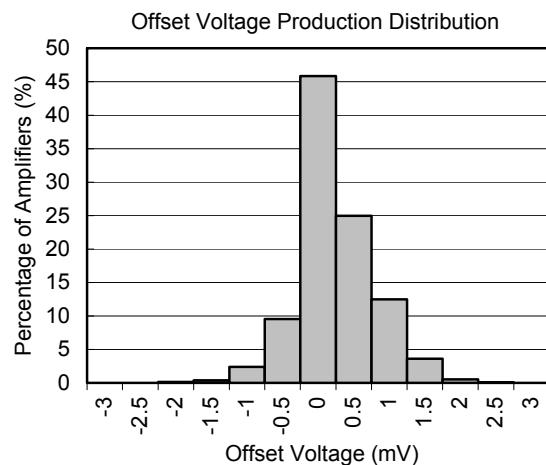
PARAMETER	CONDITIONS	SGM8631/2/3/4							
		TYP		MIN/MAX OVER TEMPERATURE					
		+25°C	+25°C	0°C to 70°C	-40°C to 85°C	-40°C to 125°C	UNITS	MIN/MAX	
INPUT CHARACTERISTICS									
Input Offset Voltage (V_{OS})		0.8	3.5	3.9	4.3	4.6	mV	MAX	
Input Bias Current (I_B)		1					pA	TYP	
Input Offset Current (I_{OS})		1					pA	TYP	
Input Common Mode Voltage Range (V_{CM})	$V_S = 5.5V$	-0.1 to +5.6					V	TYP	
Common Mode Rejection Ratio (CMRR)	$V_S = 5.5V, V_{CM} = -0.1V \text{ to } 4V$ $V_S = 5.5V, V_{CM} = -0.1V \text{ to } 5.6V$	90 83	73	70	70	65	dB	MIN	
Open-Loop Voltage Gain (A_{OL})	$R_L = 600\Omega, V_O = 0.15V \text{ to } 4.85V$ $R_L = 10k\Omega, V_O = 0.05V \text{ to } 4.95V$	97 108	90	87	86	79	dB	MIN	
Input Offset Voltage Drift ($\Delta V_{OS}/\Delta T$)		2.4					$\mu V/\text{°C}$	TYP	
OUTPUT CHARACTERISTICS									
Output Voltage Swing from Rail	$R_L = 600\Omega$ $R_L = 10k\Omega$	0.1 0.015					V	TYP	
Output Current (I_{OUT})		53	49	45	40	35	mA	MIN	
Closed-Loop Output Impedance	$f = 200\text{kHz}, G = 1$	3					Ω	TYP	
POWER-DOWN DISABLE									
Turn-On Time		4					μs	TYP	
Turn-Off Time		1.2					μs	TYP	
DISABLE Voltage-Off			0.8				V	MAX	
DISABLE Voltage-On			2				V	MIN	
POWER SUPPLY									
Operating Voltage Range			2.5 5.5	2.5 5.5	2.5 5.5	2.5 5.5	V	MIN MAX	
Power Supply Rejection Ratio (PSRR)	$V_S = +2.5V \text{ to } +5.5V$ $V_{CM} = (-V_S) + 0.5V$	91	74	72	72	68	dB	MIN	
Quiescent Current/Amplifier (I_Q)	$I_{OUT} = 0$	470	650	727	750	815	μA	MAX	
Supply Current when Disabled (SGM8633 Only)		90					nA	MAX	
DYNAMIC PERFORMANCE									
Gain-Bandwidth Product (GBP)	$R_L = 10k\Omega$	6					MHz	TYP	
Phase Margin (ϕ_O)		60					degrees	TYP	
Full Power Bandwidth (BW _P)	< 1% distortion, $R_L = 600\Omega$	250					kHz	TYP	
Slew Rate (SR)	$G = +1, 2V \text{ Step}, R_L = 10k\Omega$	3.7					V/ μs	TYP	
Settling Time to 0.1% (t_S)	$G = +1, 2V \text{ Step}, R_L = 600\Omega$	2.1					μs	TYP	
Overload Recovery Time	$V_{IN} \cdot \text{Gain} = V_S, R_L = 600\Omega$	0.9					μs	TYP	
NOISE PERFORMANCE									
Voltage Noise Density (e_n)	$f = 1\text{kHz}$	12					$\text{nV}/\sqrt{\text{Hz}}$	TYP	
Current Noise Density (i_n)	$f = 1\text{kHz}$	3					$\text{fA}/\sqrt{\text{Hz}}$	TYP	

TYPICAL PERFORMANCE CHARACTERISTICSAt $T_A = +25^\circ\text{C}$, $V_{CM} = V_S/2$, $R_L = 600\Omega$, unless otherwise noted.

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APPLICATION NOTES

Driving Capacitive Loads

The SGM8631/2/3/4 can directly drive 1000pF in unity-gain without oscillation. The unity-gain follower (buffer) is the most sensitive configuration to capacitive loading. Direct capacitive loading reduces the phase margin of amplifiers and this results in ringing or even oscillation. Applications that require greater capacitive driving capability should use an isolation resistor between the output and the capacitive load like the circuit in Figure 1. The isolation resistor R_{ISO} and the load capacitor C_L form a zero to increase stability. The bigger the R_{ISO} resistor value, the more stable V_{OUT} will be. Note that this method results in a loss of gain accuracy because R_{ISO} forms a voltage divider with the R_{LOAD} .

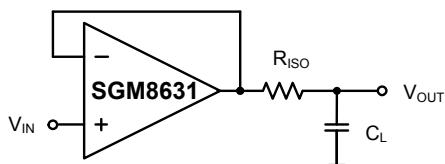


Figure 1. Indirectly Driving Heavy Capacitive Load

An improved circuit is shown in Figure 2. It provides DC accuracy as well as AC stability. R_F provides the DC accuracy by connecting the inverting signal with the output. C_F and R_{ISO} serve to counteract the loss of phase margin by feeding the high frequency component of the output signal back to the amplifier's inverting input, thereby preserving phase margin in the overall feedback loop.

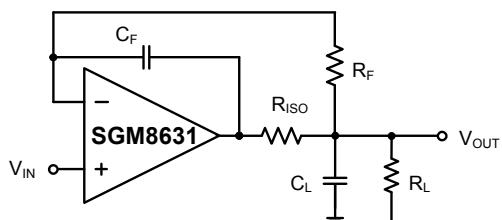


Figure 2. Indirectly Driving Heavy Capacitive Load with DC Accuracy

For non-buffer configuration, there are two other ways to increase the phase margin: (a) by increasing the amplifier's gain or (b) by placing a capacitor in parallel with the feedback resistor to counteract the parasitic capacitance associated with inverting node.

Power-Supply Bypassing and Layout

The SGM8631/2/3/4 family operates from either a single +2.5V to +5.5V supply or dual $\pm 1.25V$ to $\pm 2.75V$ supplies. For single-supply operation, bypass the power supply $+V_S$ with a $0.1\mu F$ ceramic capacitor which should be placed close to the $+V_S$ pin. For dual-supply operation, both the $+V_S$ and the $-V_S$ supplies should be bypassed to ground with separate $0.1\mu F$ ceramic capacitors. $2.2\mu F$ tantalum capacitor can be added for better performance.

Good PC board layout techniques optimize performance by decreasing the amount of stray capacitance at the op amp's inputs and output. To decrease stray capacitance, minimize trace lengths and widths by placing external components as close to the device as possible. Use surface-mount components whenever possible.

For the operational amplifier, soldering the part to the board directly is strongly recommended. Try to keep the high frequency big current loop area small to minimize the EMI (electromagnetic interfacing).

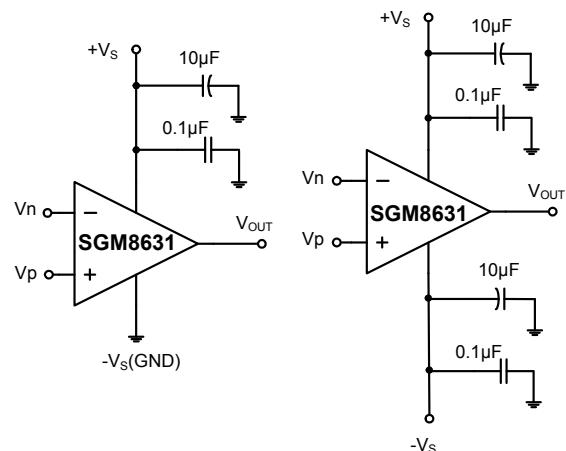


Figure 3. Amplifier with Bypass Capacitors

Grounding

A ground plane layer is important for SGM8631/2/3/4 circuit design. The length of the current path speed currents in an inductive ground return will create an unwanted voltage noise. Broad ground plane areas will reduce the parasitic inductance.

Input-to-Output Coupling

To minimize capacitive coupling, the input and output signal traces should not be parallel. This helps reduce unwanted positive feedback.

TYPICAL APPLICATION CIRCUITS

Differential Amplifier

The circuit shown in Figure 4 performs the difference function. If the resistor ratios are equal ($R_4/R_3 = R_2/R_1$), then $V_{OUT} = (V_p - V_n) \times R_2/R_1 + V_{REF}$.

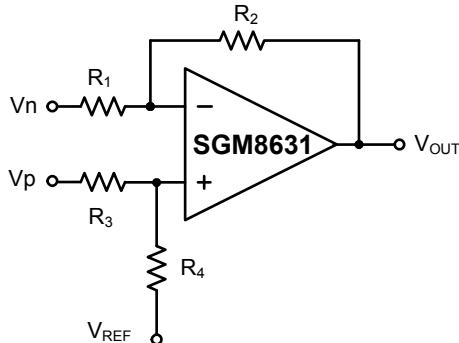


Figure 4. Differential Amplifier

Instrumentation Amplifier

The circuit in Figure 5 performs the same function as that in Figure 4 but with a high input impedance.

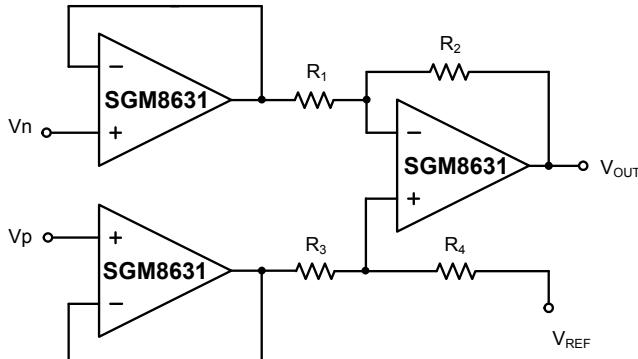


Figure 5. Instrumentation Amplifier

Low Pass Active Filter

The low pass filter shown in Figure 6 has a DC gain of $(-R_2/R_1)$ and the -3dB corner frequency is $1/2\pi R_2 C$. Make sure the filter bandwidth is within the bandwidth of the amplifier. The large values of feedback resistors can couple with parasitic capacitance and cause undesired effects such as ringing or oscillation in high-speed amplifiers. Keep resistor values as low as possible and consistent with output loading consideration.

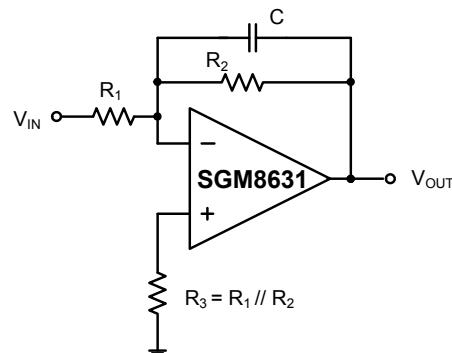
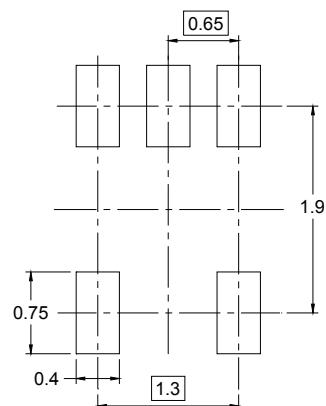
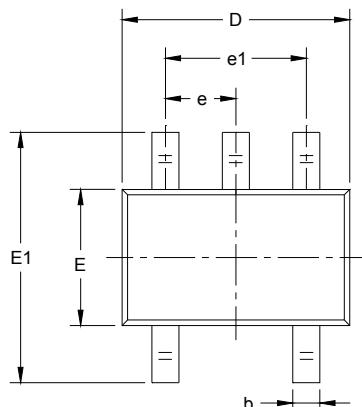


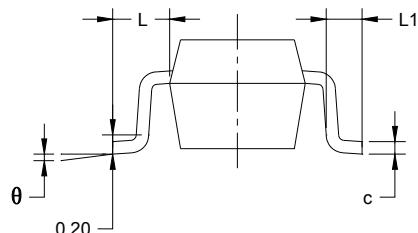
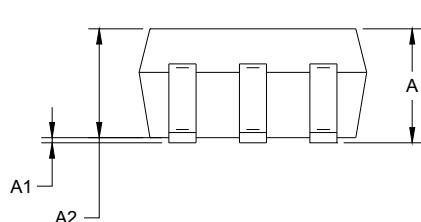
Figure 6. Low Pass Active Filter

PACKAGE OUTLINE DIMENSIONS

SC70-5



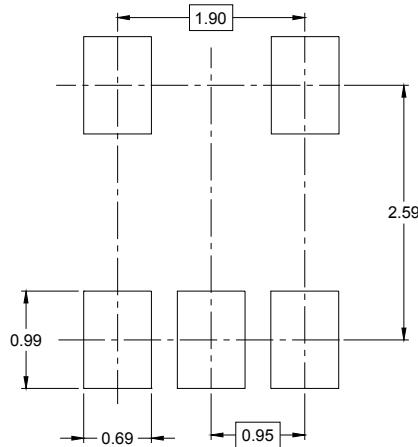
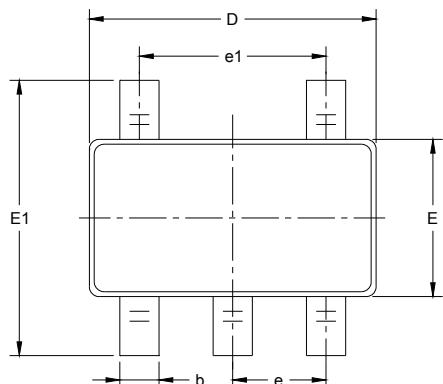
RECOMMENDED LAND PATTERN (Unit: mm)



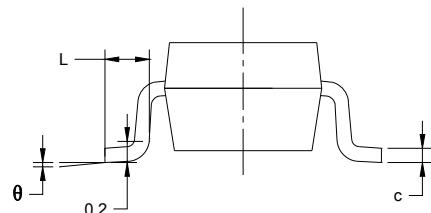
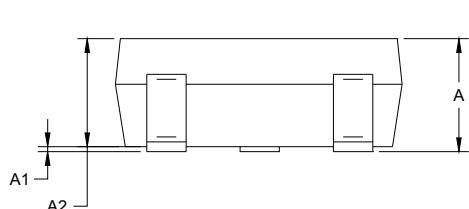
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.65 TYP		0.026 TYP	
e1	1.300 BSC		0.051 BSC	
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

SOT-23-5



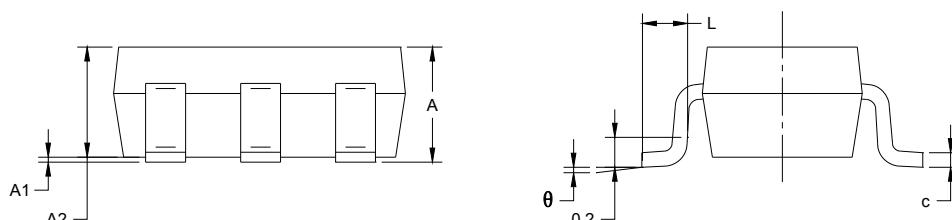
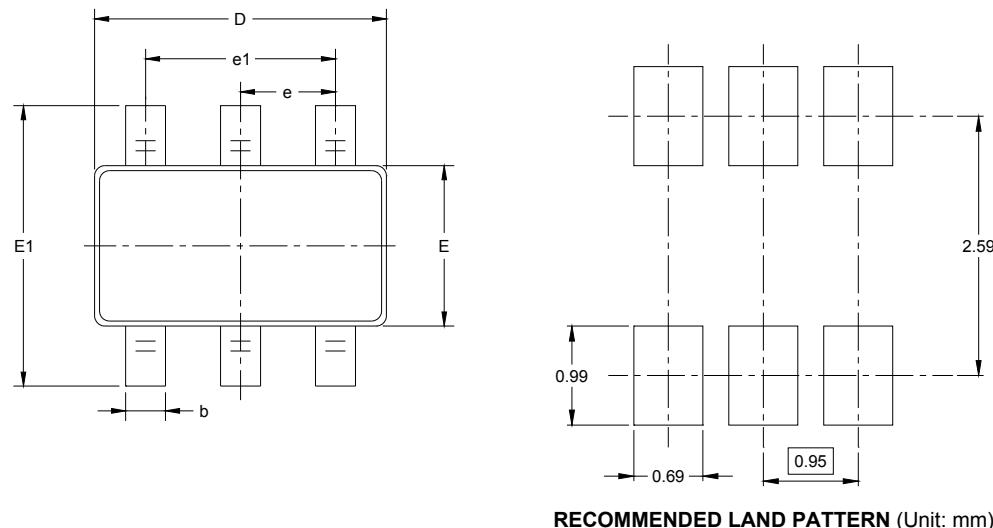
RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.900 BSC		0.075 BSC	
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

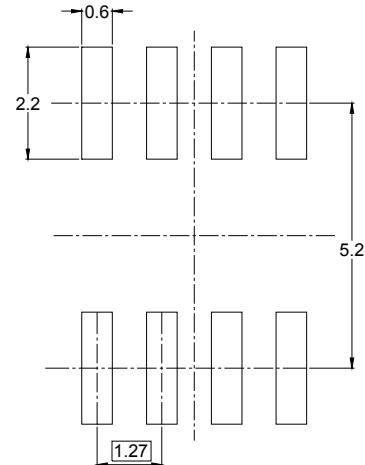
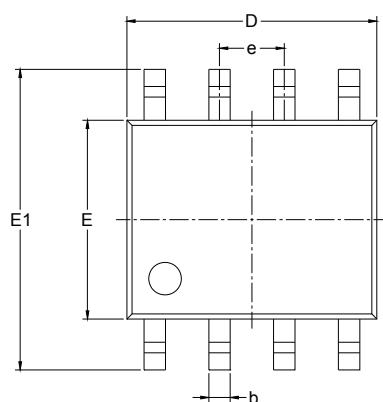
SOT-23-6



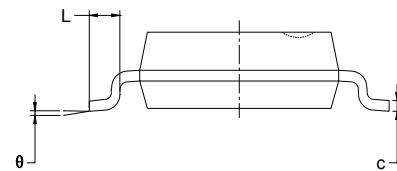
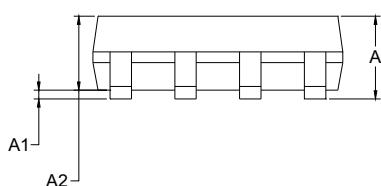
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.900 BSC		0.075 BSC	
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

SOIC-8



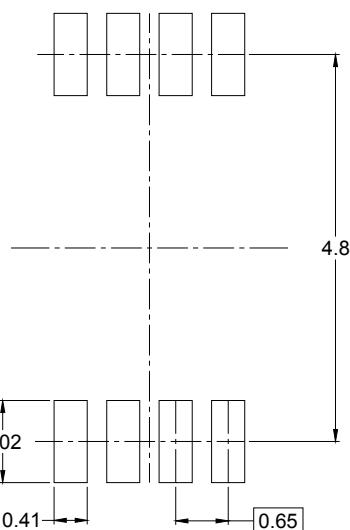
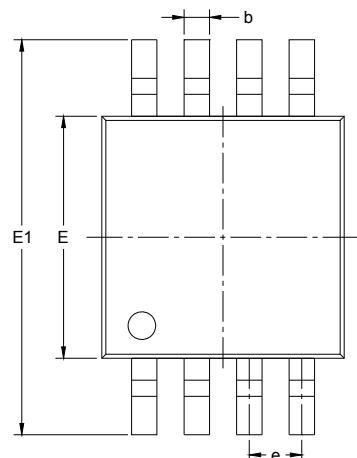
RECOMMENDED LAND PATTERN (Unit: mm)



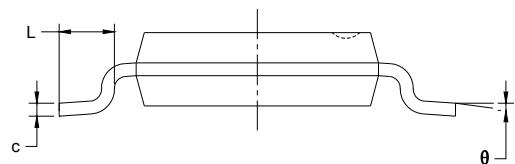
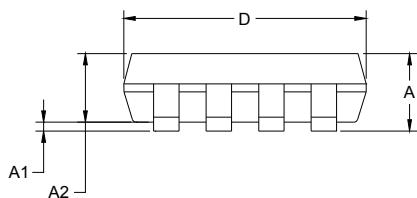
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.27 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

MSOP-8



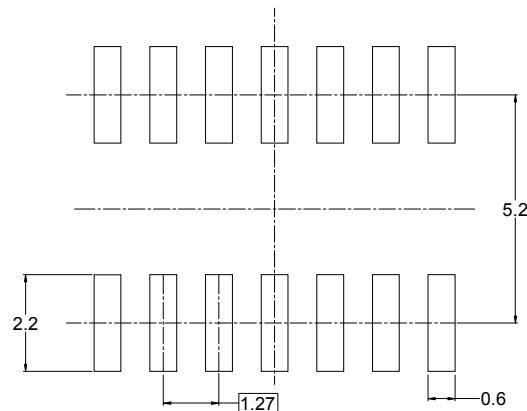
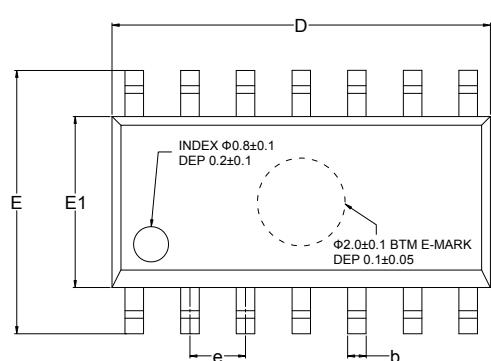
RECOMMENDED LAND PATTERN (Unit: mm)



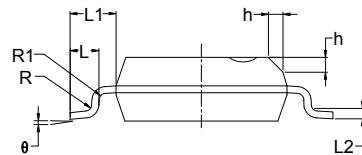
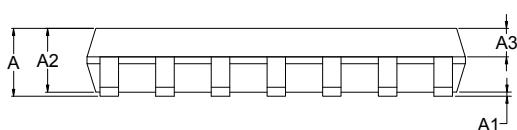
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
e	0.650 BSC		0.026 BSC	
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

PACKAGE OUTLINE DIMENSIONS

SOIC-14



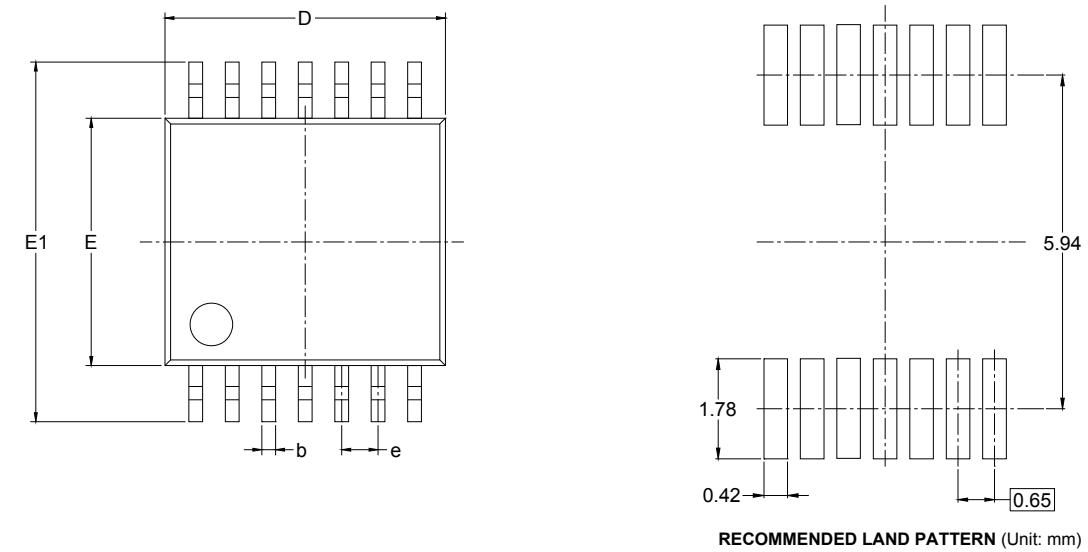
RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters			Dimensions In Inches		
	MIN	MOD	MAX	MIN	MOD	MAX
A	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.004		0.010
A2	1.25		1.65	0.049		0.065
A3	0.55		0.75	0.022		0.030
b	0.36		0.49	0.014		0.019
D	8.53		8.73	0.336		0.344
E	5.80		6.20	0.228		0.244
E1	3.80		4.00	0.150		0.157
e	1.27 BSC			0.050 BSC		
L	0.45		0.80	0.018		0.032
L1	1.04 REF			0.040 REF		
L2	0.25 BSC			0.01 BSC		
R	0.07			0.003		
R1	0.07			0.003		
h	0.30		0.50	0.012		0.020
θ	0°		8°	0°		8°

PACKAGE OUTLINE DIMENSIONS

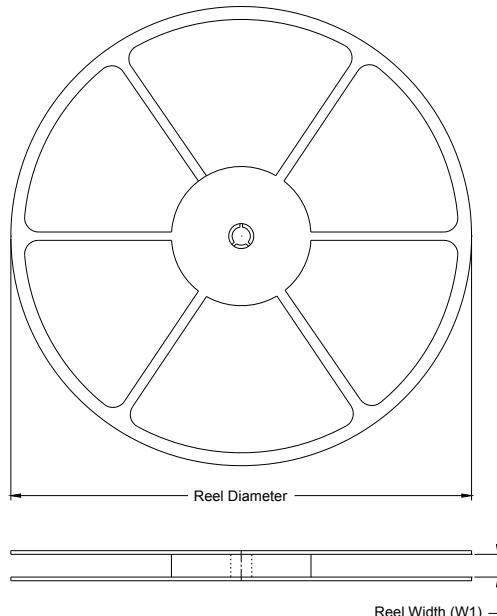
TSSOP-14



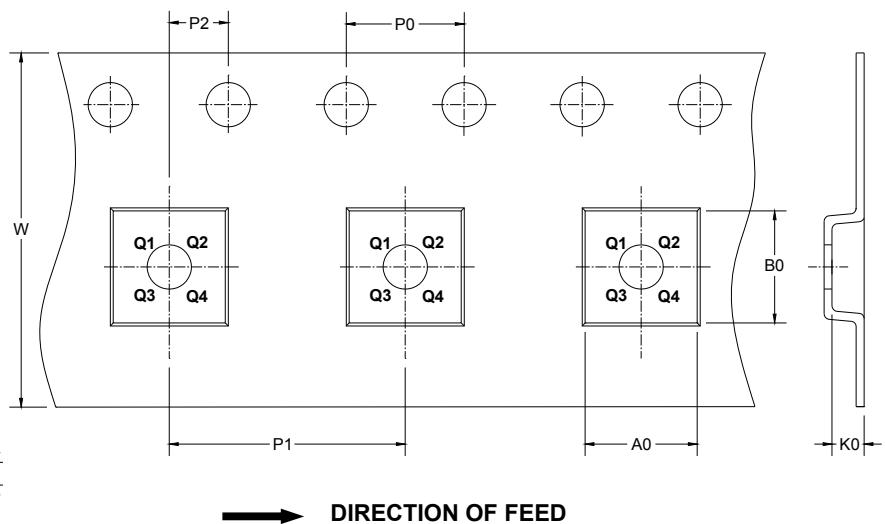
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A		1.100		0.043
A1	0.050	0.150	0.002	0.006
A2	0.800	1.000	0.031	0.039
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	4.900	5.100	0.193	0.201
E	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
e	0.650 BSC		0.026 BSC	
L	0.500	0.700	0.02	0.028
H	0.25 TYP		0.01 TYP	
θ	1°	7°	1°	7°

TAPE AND REEL INFORMATION

REEL DIMENSIONS



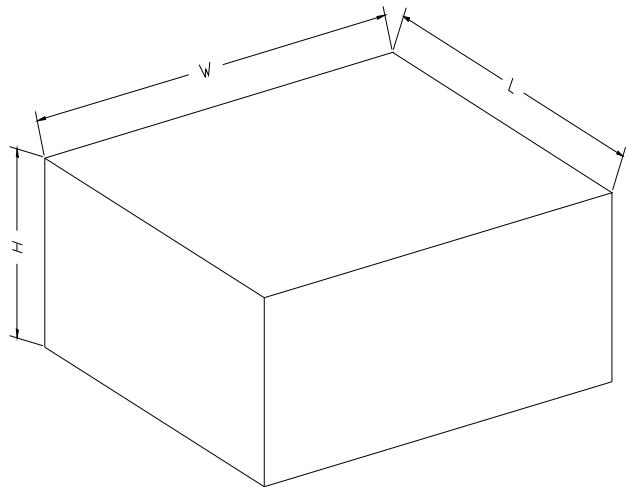
TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-5	7"	9.5	3.17	3.23	1.37	4.0	4.0	2.0	8.0	Q3
SC70-5	7"	9.5	2.25	2.55	1.20	4.0	4.0	2.0	8.0	Q3
SOT-23-6	7"	9.5	3.17	3.23	1.37	4.0	4.0	2.0	8.0	Q3
SOIC-8	13"	12.4	6.4	5.4	2.1	4.0	8.0	2.0	12.0	Q1
MSOP-8	13"	12.4	5.2	3.3	1.5	4.0	8.0	2.0	12.0	Q1
SOIC-14	13"	16.4	6.6	9.3	2.1	4.0	8.0	2.0	16.0	Q1
TSSOP-14	13"	12.4	6.95	5.6	1.2	4.0	8.0	2.0	12.0	Q1

CARTON BOX DIMENSIONS

NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18
13"	386	280	370	5